



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _A = +25°C
-30V	$90m\Omega$ @ $V_{GS} = -10V$	-3.3A
-30 V	134mΩ @ $V_{GS} = -4.5V$	-2.5A

Description

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP3165LQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

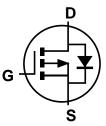
https://www.diodes.com/quality/product-definitions/

Mechanical Data

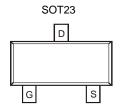
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ©3
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)



Top View



Internal Schematic



Top View

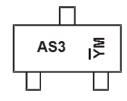
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3165LQ-7	SOT23	3000/Tape & Reel
DMP3165LQ-13	SOT23	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



AS3 = Product Type Marking Code $\overline{Y}M$ = Date Code Marking \overline{Y} = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н		J	K	L	М	N	0	Р	R	S	T
		1	1	1	1	1	1	-	_	_		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Character	istic		Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage		V _{GSS}	±20	V	
Drain Current (Note 6) V _{GS} = -10V	T _A = +25°C T _A = +70°C	lo	-3.3 -2.7	А	
Pulsed Drain Current (380µs Pulse, I	Outy Cycle = 1	%)	IDM	-13	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	0.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	159	°C/W
Total Power Dissipation (Note 6)		PD	1.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _θ JA	98	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

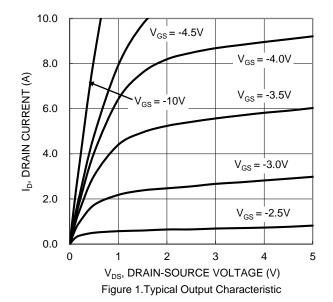
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-800	nA	V _{DS} = -30V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±80 ±800	nA	V _{GS} = ±12V, V _{DS} = 0V V _{GS} = ±15V, V _{DS} = 0V	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-1.3	_	-2.1	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance	Descent		59	90	mΩ	$V_{GS} = -10V, I_{D} = -2.7A$	
Static Dialii-Source On-Resistance	RDS(ON)	_	100	134	11122	$V_{GS} = -4.5V$, $I_{D} = -2.0A$	
Diode Forward Voltage	V _{SD}	_	-0.83	-1.26	V	V _{GS} = 0V, I _S = -2.7A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		300	_	pF	<u></u>	
Output Capacitance	Coss		52	_	pF	V _{DS} = -10V, V _{GS} = 0V f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	35	_	pF	1 - 1.0WH12	
Gate Resistance	Rg	_	12.5	_	Ω	$V_{GS} = 0V$, $V_{DS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	1.0	_	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	_	2.0	_	nC	$V_{GS} = -10V/-4.5V,$	
Gate-Source Charge	Qgs	_	0.2	_	nC	$V_{DS} = -15V, I_{D} = -3A$	
Gate-Drain Charge	Q _{gd}	_	0.5	_	nC		
Turn-On Delay Time	t _{D(ON)}		3.7	_	ns		
Turn-On Rise Time	t _R		5.5	_	ns	$V_{DS} = -15V, V_{GS} = -10V,$	
Turn-Off Delay Time	tD(OFF)		13.6	_	ns	$R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	tF		8.4	_	ns		
Reverse Recovery Time	trr		6.5	_	ns	$I_F = -1.0A$, $di/dt = 100A/\mu s$	
Reverse Recovery Charge	Qrr		1.2		nC	IF = -1.0A, di/dt = 100A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

^{7.} Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.





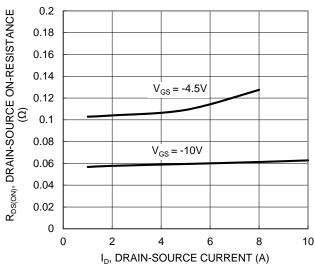


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

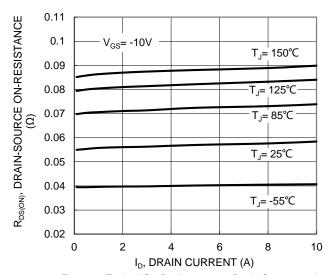


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

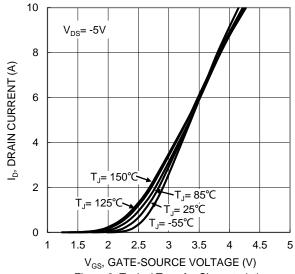


Figure 2. Typical Transfer Characteristic

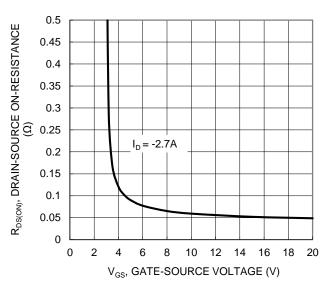


Figure 4. Typical Transfer Characteristic

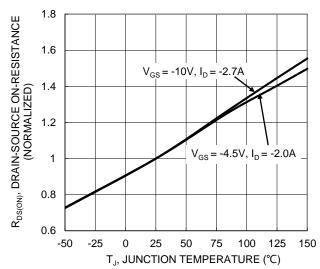


Figure 6. On-Resistance Variation with Temperature



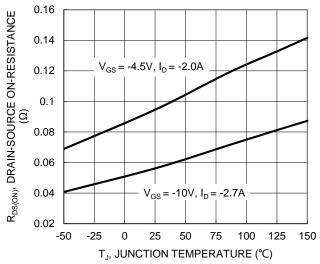


Figure 7. On-Resistance Variation with Temperature

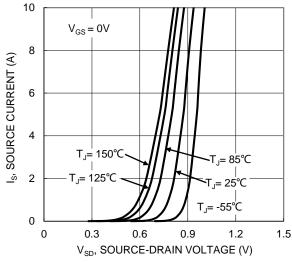
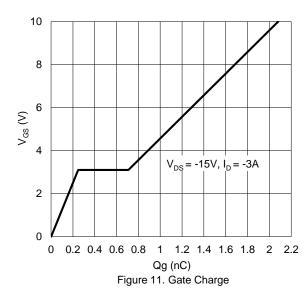


Figure 9. Diode Forward Voltage vs. Current



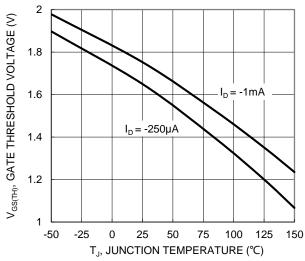
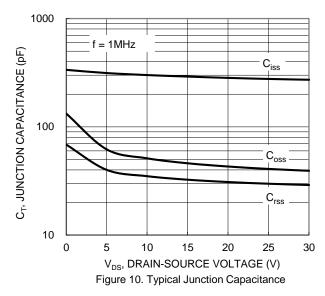
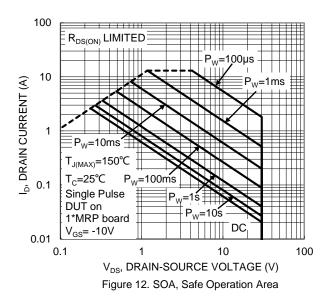


Figure 8. Gate Threshold Variation vs. JunctionTemperature







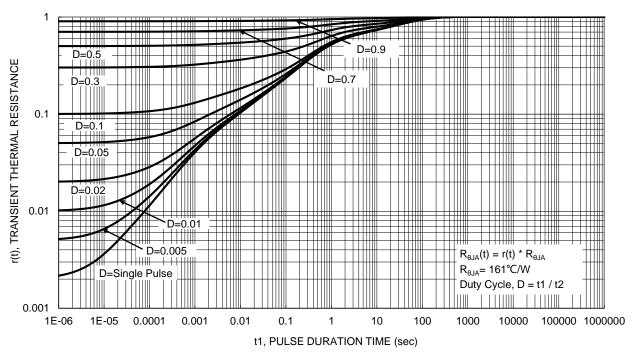


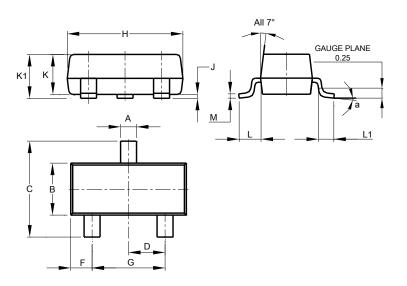
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

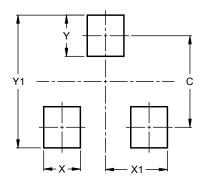


SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
C	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
M	0.085	0.150	0.110			
а	0°	8°				
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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